



Description

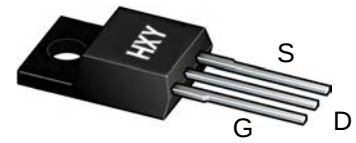
The 10N65 can be used in various power switching circuit for system miniaturization and higher efficiency. The package form is TO-220F, which accords with the RoHS standard.

General Features

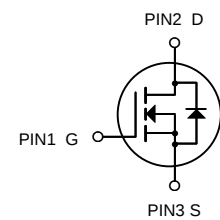
$V_{DS} = 650V, I_D = 10A$
 $R_{DS(ON)} < 1.05\Omega @ V_{GS} = 10V$

Application

- Power switch circuit of adaptor and charger.



TO-220F
(TO-220F-3L)



N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Marking	Units Tube
10N65	TO-220F(TO-220F-3L)	10N65 XXX YYYY	50

Absolute Maximum Ratings@ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	650	V
V_{GS}	Gate-Source Voltage	± 30	V
$I_D @ T_C = 25^\circ\text{C}$	Drain Current, $V_{GS} @ 4.5V$	10	A
$I_D @ T_C = 100^\circ\text{C}$	Drain Current, $V_{GS} @ 4.5V$	6.3	A
IDM	Pulsed Drain Current ¹	40	A
$P_D @ T_C = 25^\circ\text{C}$	Total Power Dissipation	40	W
E_{AS}	Single Pulse Avalanche Energy ⁴	500	mJ
TSTG	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$



Electrical Characteristics (Tc= 25℃ unless otherwise specified):

OFF Characteristics						
Symbol	Parameter	Test Conditions	Rating			Unit
			Min.	Typ.	Max.	
V _{DSS}	Drain to Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	650	--	--	V
ΔBV _{DSS} /ΔT _J	Bvdss Temperature Coefficient	ID=250uA,Reference25℃	--	0.7	--	V/℃
I _{DSS}	Drain to Source Leakage Current	V _{DS} =650V, V _{GS} = 0V, T _a = 25℃	--	--	1	μA
		V _{DS} =520V, V _{GS} = 0V, T _a = 125℃	--	--	100	μA
I _{GSS(F)}	Gate to Source Forward Leakage	V _{GS} =+30V	--	--	100	nA
I _{GSS(R)}	Gate to Source Reverse Leakage	V _{GS} =-30V	--	--	-100	nA

ON Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
R _{DS(ON)}	Drain-to-Source On-Resistance	V _{GS} =10V,I _D =5A	--	0.86	1.05	Ω
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μA	2.0	--	4.0	V
Pulse width tp≤300μs, δ ≤2%						

Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
g _{fs}	Forward Transconductance	V _{DS} =15V, I _D =5A	--	9.5	--	S
C _{iss}	Input Capacitance	V _{GS} = 0V V _{DS} = 25V f = 1.0MHz	--	1642	--	pF
C _{oss}	Output Capacitance		--	128	--	
C _{rss}	Reverse Transfer Capacitance		--	7	--	

Resistive Switching Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
t _{d(ON)}	Turn-on Delay Time	I _D =10A V _{DD} = 325V R _G =10Ω	--	27	--	ns
t _r	Rise Time		--	22	--	
t _{d(OFF)}	Turn-Off Delay Time		--	53	--	
t _f	Fall Time		--	24	--	
Q _g	Total Gate Charge	I _D =10A V _{DD} =520V V _{GS} = 10V	--	32	--	nC
Q _{gs}	Gate to Source Charge		--	8	--	
Q _{gd}	Gate to Drain ("Miller")Charge		--	12	--	



Source-Drain Diode Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
I _S	Continuous Source Current (Body Diode)		--	--	10	A
I _{SM}	Maximum Pulsed Current (Body Diode)		--	--	40	A
V _{SD}	Diode Forward Voltage	I _S =10A, V _{GS} =0V	--	--	1.5	V
trr	Reverse Recovery Time	I _S =10A, T _J = 25℃ dI _F /dt=100A/us, V _{GS} =0V	--	528	--	ns
Qrr	Reverse Recovery Charge		--	3220	--	nC
I _{RRM}	Reverse Recovery Current		--	12.2	--	A
Pulse width tp≤300μs, δ ≤2%						

Symbol	Parameter	Typ.	Units
$R_{\theta JC}$	Junction-to-Case	3.13	$^{\circ}C/W$
$R_{\theta JA}$	Junction-to-Ambient	62.5	$^{\circ}C/W$

^{a1}: Repetitive rating; pulse width limited by maximum junction temperature

^{a2}: $L=10mH, I_D=10A, Start T_j=25^{\circ}C$

^{a3}: $I_{SD}=10A, di/dt \leq 100A/us, V_{DD} \leq BV_{DS}, Start T_j=25^{\circ}C$



Characteristics Curve:

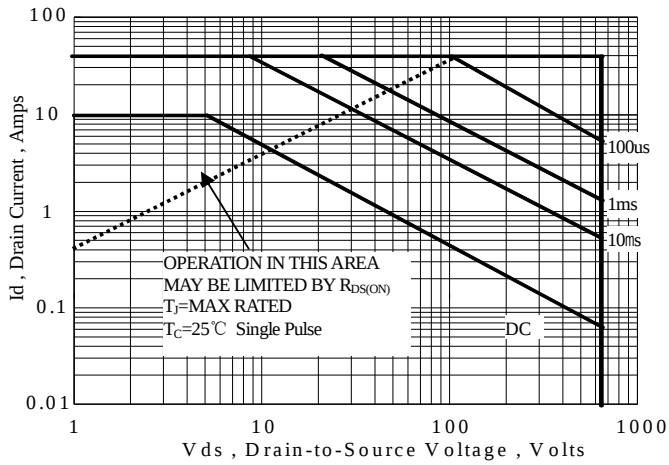


Figure 1 Maximum Forward Bias Safe Operating Area

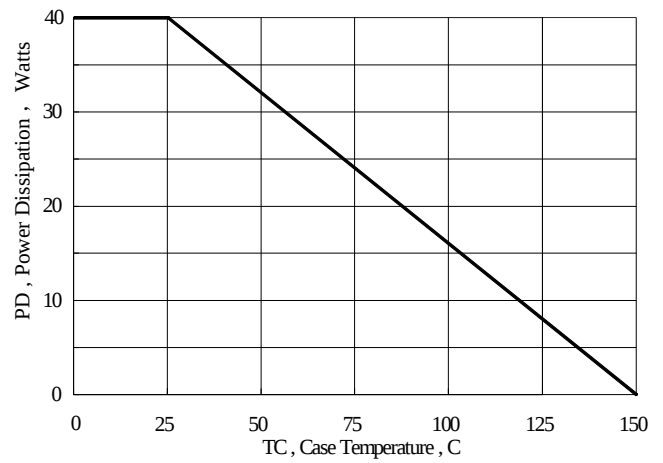


Figure 2 Maximum Power Dissipation vs Case Temperature

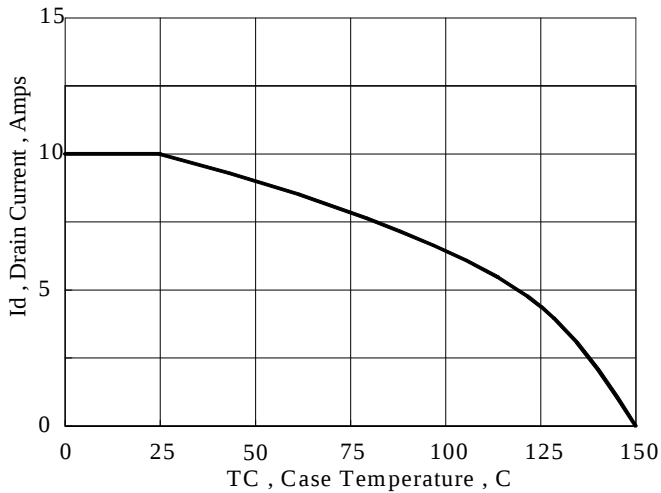


Figure 3 Maximum Continuous Drain Current vs Case Temperature

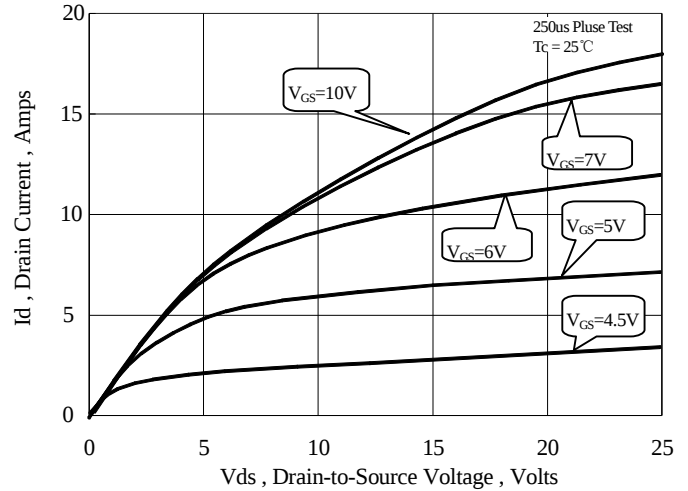


Figure 4 Typical Output Characteristics

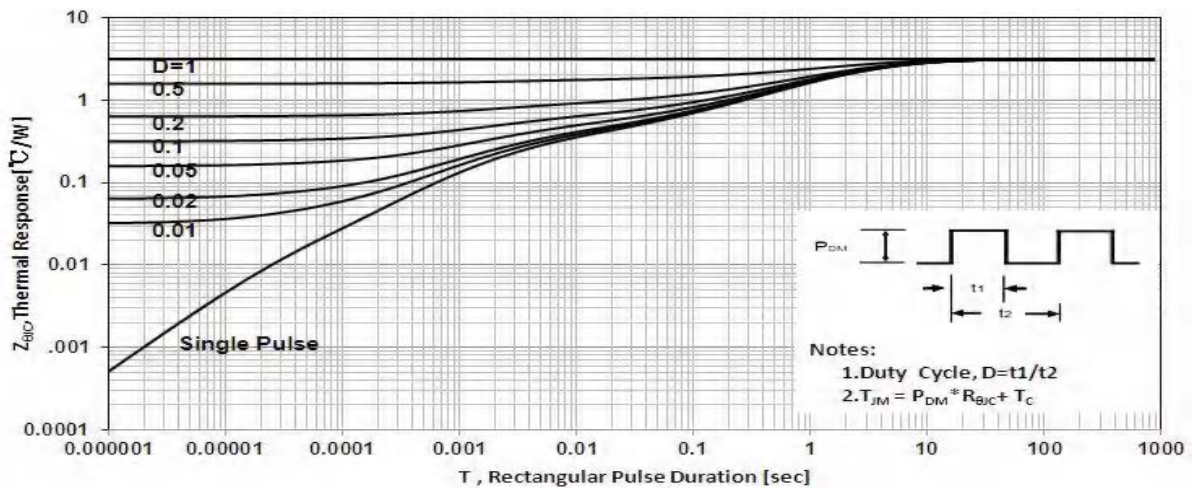


Figure 5 Maximum Effective Thermal Impedance, Junction to Case

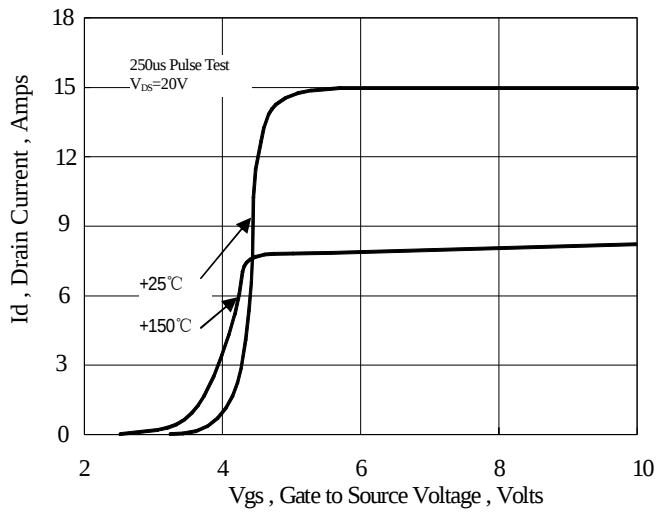


Figure 6 Typical Transfer Characteristics

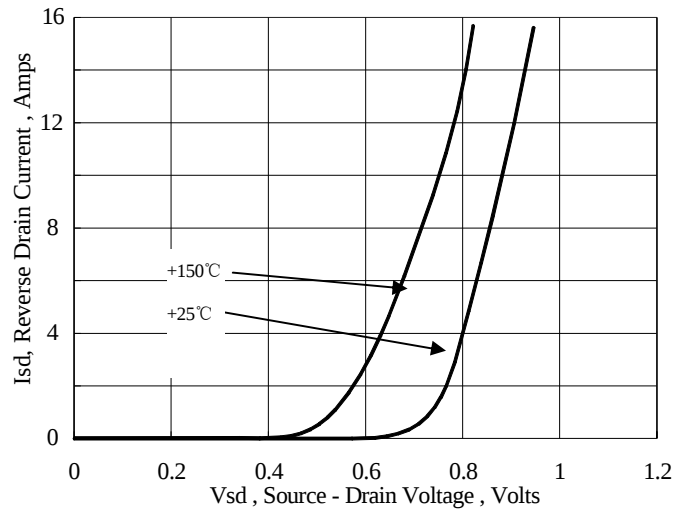


Figure 7 Typical Body Diode Transfer Characteristics

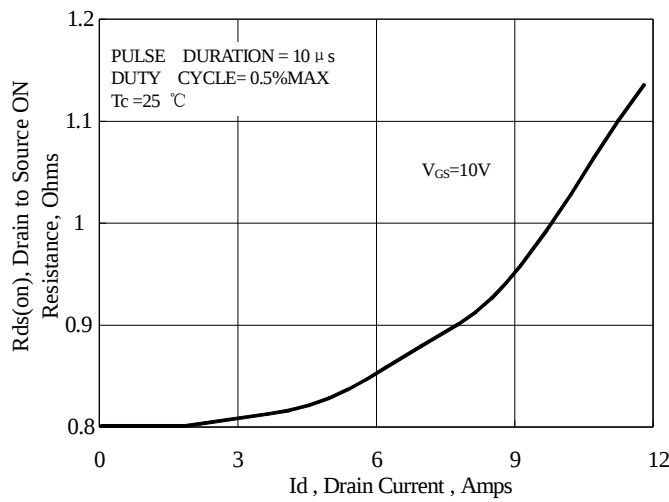


Figure 8 Typical Drain to Source ON Resistance vs Drain Current

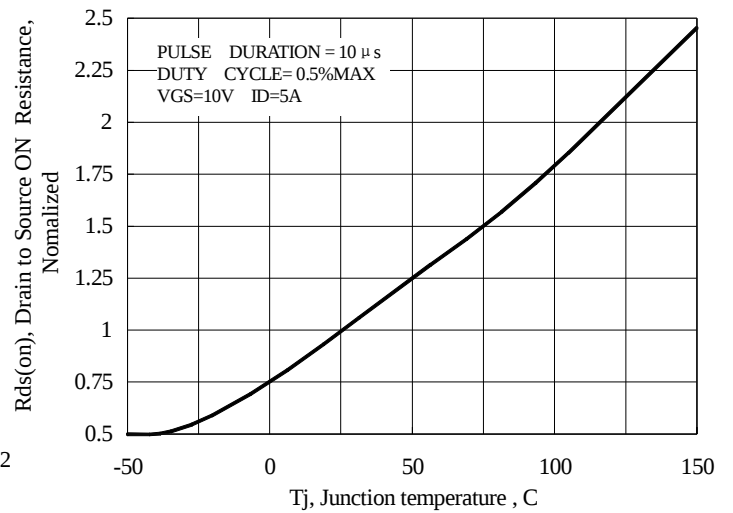


Figure 9 Typical Drain to Source on Resistance vs Junction Temperature

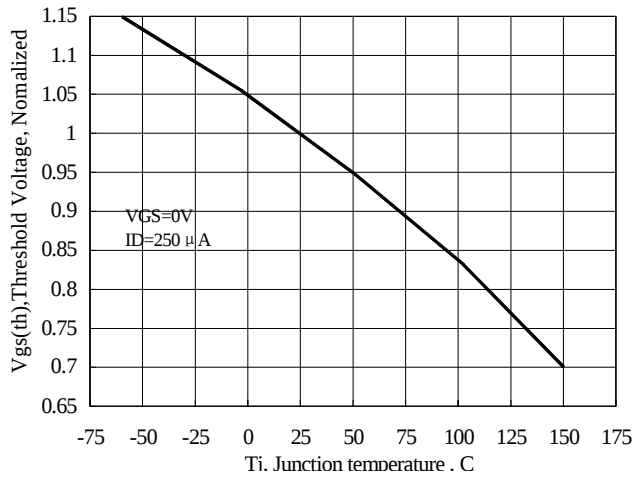


Figure 10 Typical Theshold Voltage vs Junction Temperature

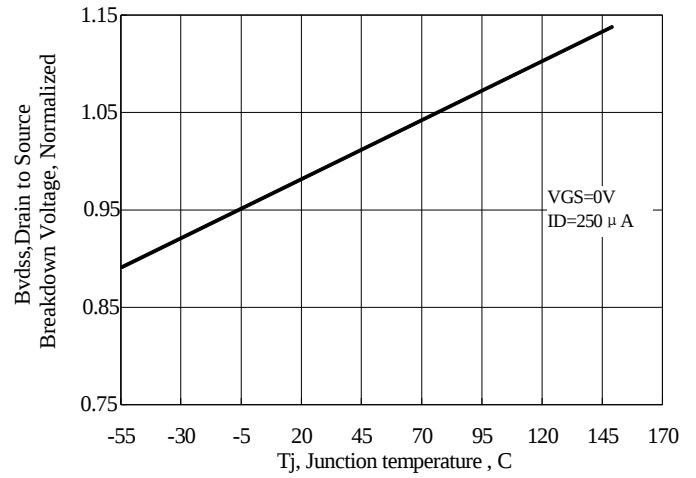


Figure 11 Typical Breakdown Voltage vs Junction Temperature

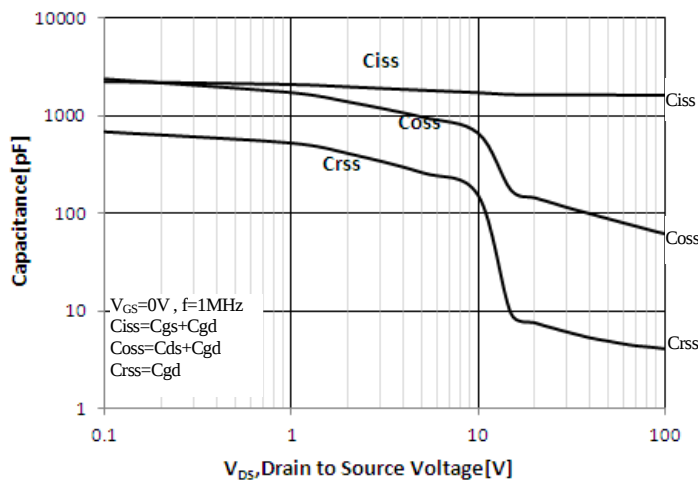


Figure 12 Typical Capacitance vs Drain to Source Voltage

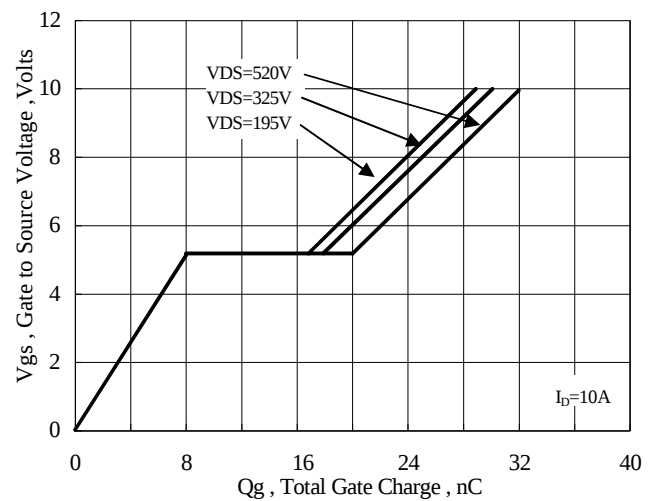


Figure 13 Typical Gate Charge vs Gate to Source Voltage



Test Circuit and Waveform

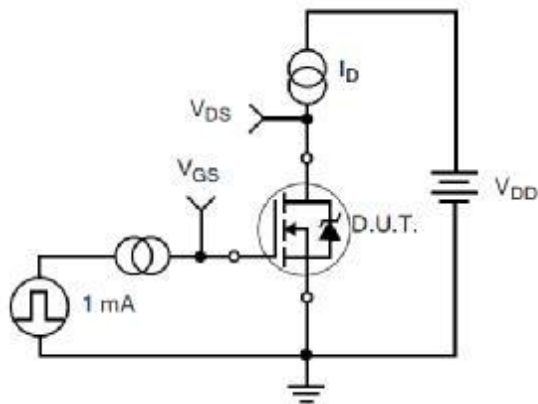


Figure 17. Gate Charge Test Circuit

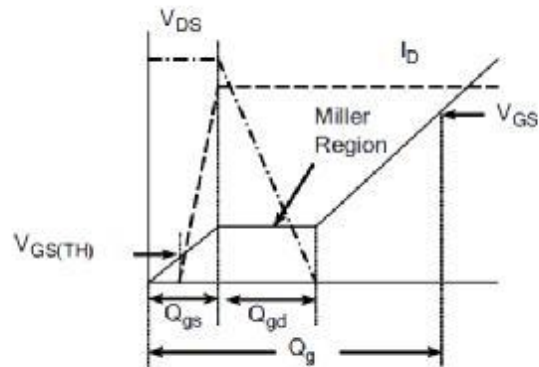


Figure 18. Gate Charge Waveform

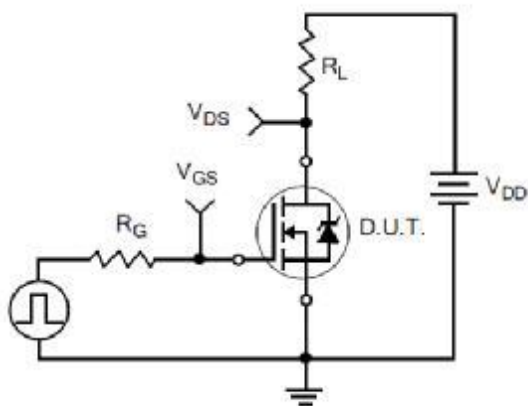


Figure 19. Resistive Switching Test Circuit

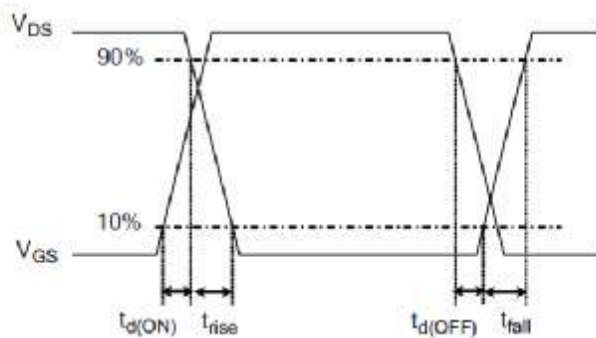


Figure 20. Resistive Switching Waveforms

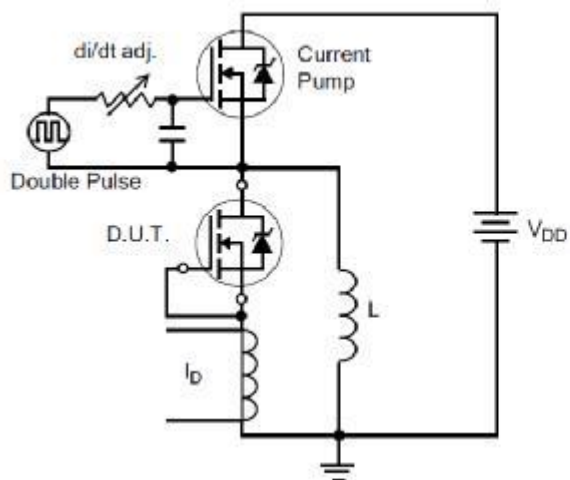


Figure 21. Diode Reverse Recovery Test Circuit

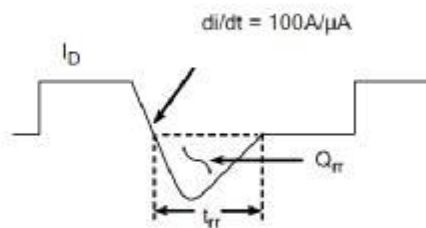


Figure 22. Diode Reverse Recovery Waveform

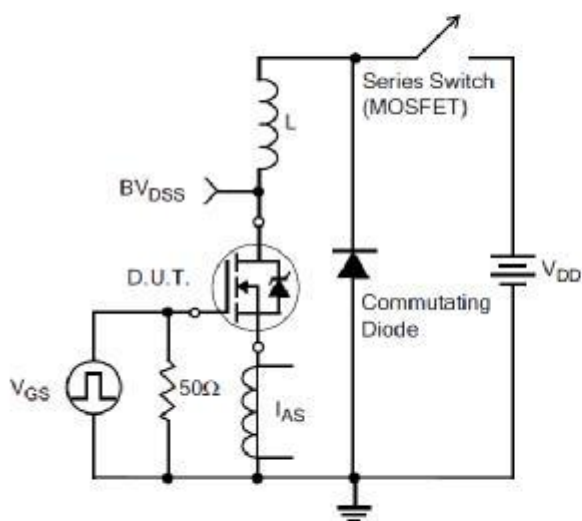


Figure 23. Unclamped Inductive Switching Test Circuit

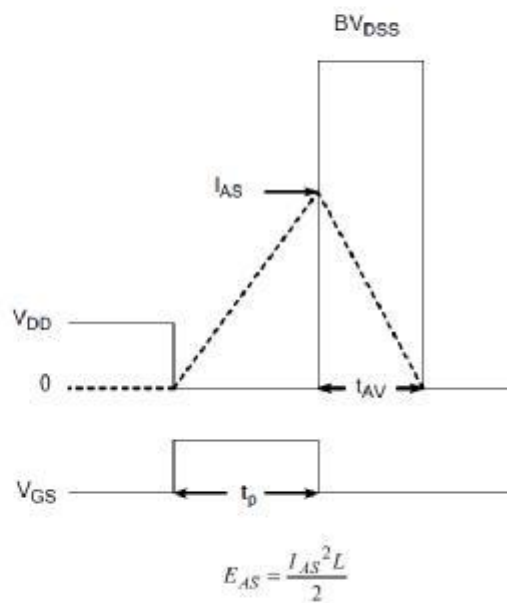
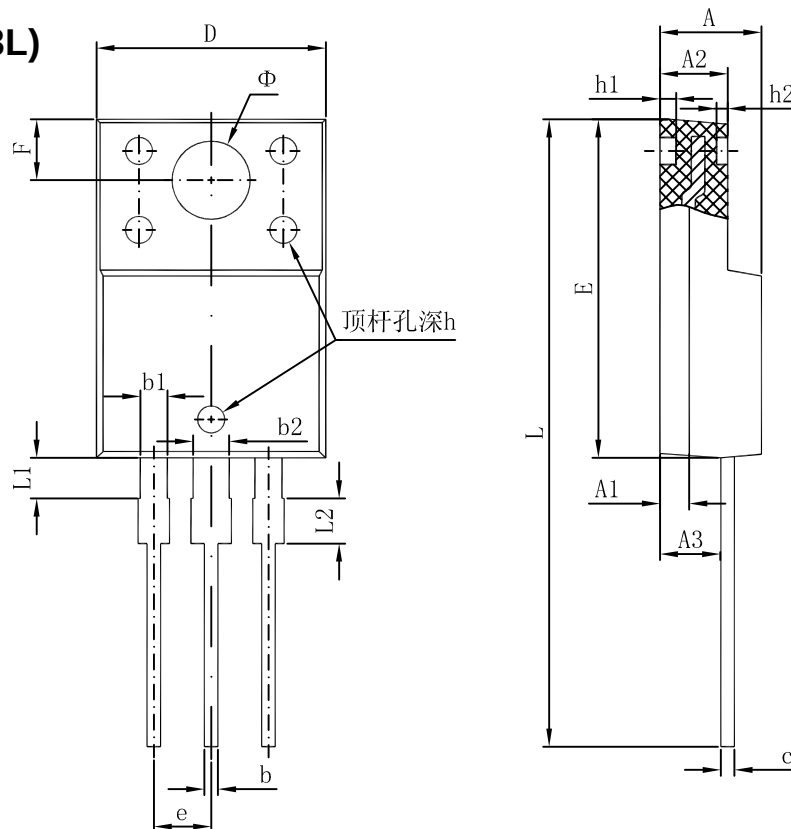


Figure 24. Unclamped Inductive Switching Waveforms



Package Information

TO-220F (TO-220F-3L)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.300	4.700	0.169	0.185
A1	1.300 REF.		0.051 REF.	
A2	2.800	3.200	0.110	0.126
A3	2.500	2.900	0.098	0.114
b	0.500	0.750	0.020	0.030
b1	1.100	1.350	0.043	0.053
b2	1.500	1.750	0.059	0.069
c	0.500	0.750	0.020	0.030
D	9.960	10.360	0.392	0.408
E	14.800	15.200	0.583	0.598
e	2.540 TYP.		0.100 TYP.	
F	2.700 REF.		0.106 REF.	
Φ	3.500 REF.		0.138 REF.	
h	0.000	0.300	0.000	0.012
h1	0.800 REF.		0.031 REF.	
h2	0.500 REF.		0.020 REF.	
L	28.000	28.400	1.102	1.118
L1	1.700	1.900	0.067	0.075
L2	1.900	2.100	0.075	0.083



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